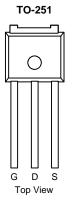
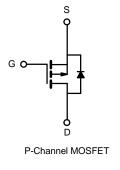


## STD2030PLS-VB Datasheet P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)		
- 30	0.018 at V <sub>GS</sub> = - 10 V	- 40	13 nC		
- 30	0.022 at V <sub>GS</sub> = - 4.5 V	- 35	13110		





#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- Trench Power MOSFET
- 100 % Rg Tested

#### **APPLICATIONS**

- Load Switch
- Battery Switch

ABSOLUTE MAXIMUM RATINGS T	$_{\rm A}$ = 25 °C, unless othe	erwise noted		
Parameter			Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 30	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
	T <sub>C</sub> = 25 °C		- 40	
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 35	
Continuous Drain Current (1) = 150°C)	T <sub>A</sub> = 25 °C	Ι <sub>D</sub>	- 30.0 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C	-	- 28 <sup>a, b</sup>	Α
Pulsed Drain Current	I <sub>DM</sub> - 150	- 150		
Northennes Course Ducia Diada Coursent	T <sub>C</sub> = 25 °C	L.	- 3.5	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>a, b</sup>	
	T <sub>C</sub> = 25 °C		40	
Movimum Dower Dissinction	T <sub>C</sub> = 70 °C	P	32	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	vv
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	40	50	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	24	30	C/VV	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 95 °C/W.

d. Based on  $T_C = 25$  °C.

HALOGEN

Available

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	2/T i		- 31			
V <sub>GS(th)</sub> Temperature Coefficient	$\frac{\Delta V_{GS(th)}/T_J}{\Delta V_{GS(th)}/T_J}$ I <sub>D</sub> = - 250 µA			4.5		- mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 1.0		- 2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Casta Malta na Duain Cumpat	-	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 V$ , $V_{GS} = -10 V$	- 20			Α	
	_	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 7.0 A		0.018			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5.6 A		0.022		Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 7.0 A		18		S	
Dynamic <sup>b</sup>						<u> </u>	
Input Capacitance	C <sub>iss</sub>			1455			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		180		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			145			
Tatal Oata Ohanna		$V_{DS}$ = - 15 V, $V_{GS}$ = - 10 V, $I_{D}$ = - 7.0 A		25	38		
Total Gate Charge	Q <sub>g</sub>		13	20			
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7.0 A		3.5		nC	
Gate-Drain Charge	Q <sub>gd</sub>			5.5		1	
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.4	2.0	4.0	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, R <sub>L</sub> = 2.7 $\Omega$		13	20	1	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 5.6 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		23	35	1	
Fall Time	t <sub>f</sub>			9	18		
Turn-On Delay Time	t <sub>d(on)</sub>			38	57	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, R <sub>L</sub> = 2.7 $\Omega$		89	134		
Turn-Off DelayTime	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 5.6 A, $\text{V}_\text{GEN}$ = - 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		22	33	]	
Fall Time	t <sub>f</sub>			11	17	1	
Drain-Source Body Diode Characteris	stics				•	•	
Continous Source-Drain Diode Current		T <sub>C</sub> = 25 °C			- 6.5	٨	
Pulse Diode Forward Current	I <sub>SM</sub>				- 30	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 5.6 A, V <sub>GS</sub> = 0 V		- 0.71	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			22	33	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			17	26	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = - 5.6 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		13			
Reverse Recovery Rise Time	t <sub>b</sub>			9		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

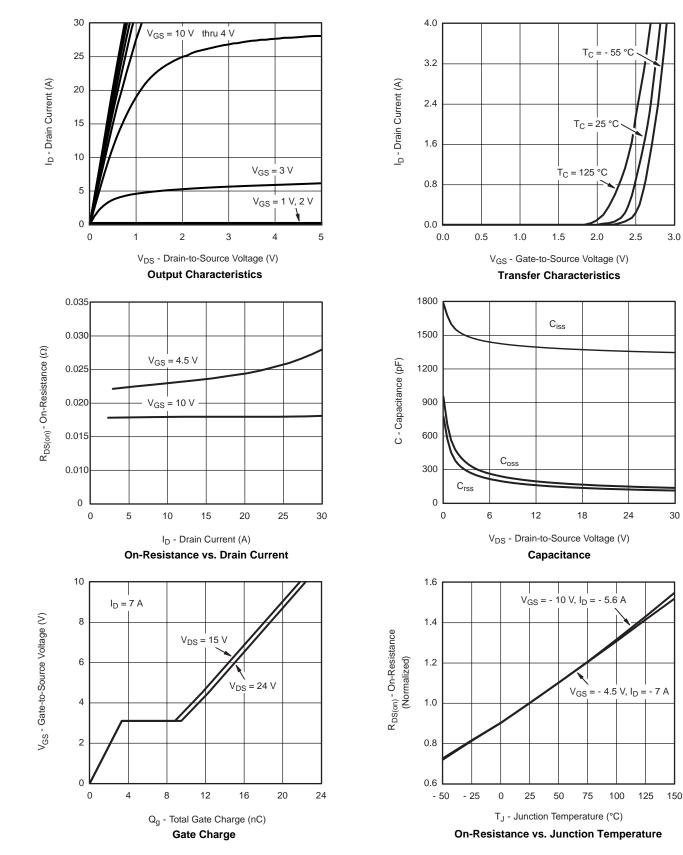
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

emi

Bsemi





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

30

100

10

1

0.1

2.1

1.9

1.7

1.5

1.3

1.1

- 50

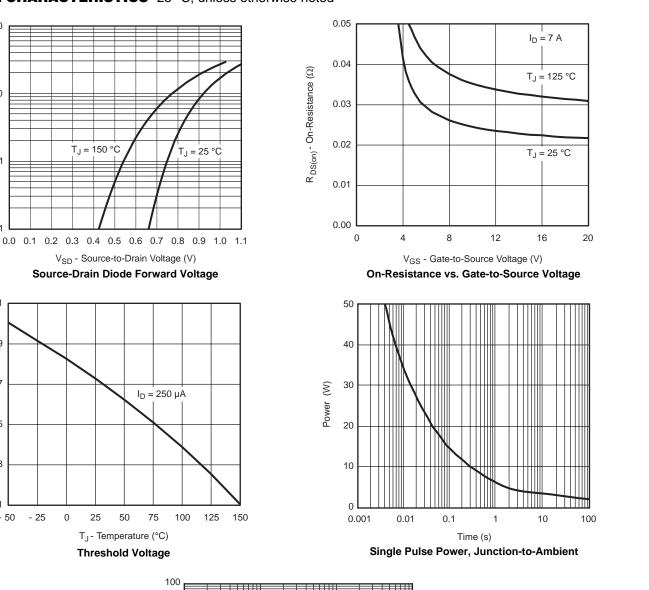
- 25

0

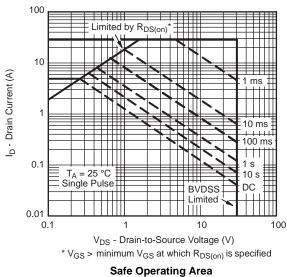
25

V<sub>GS(th)</sub> (V)

I<sub>S</sub> - Source Current (A)



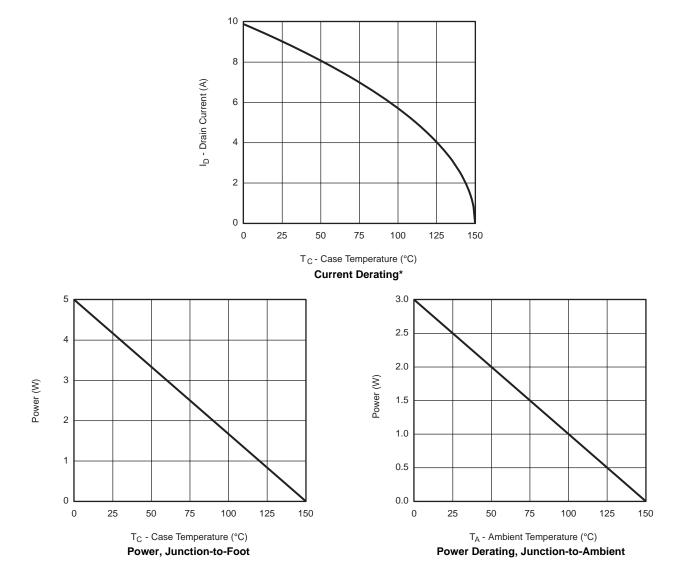
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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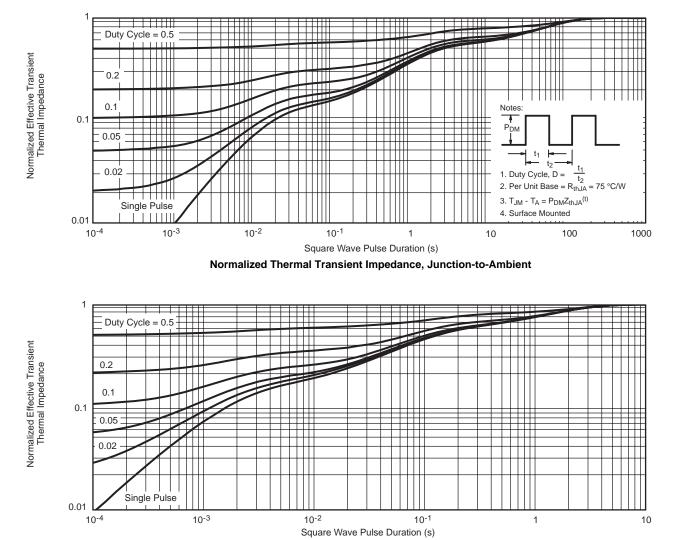
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



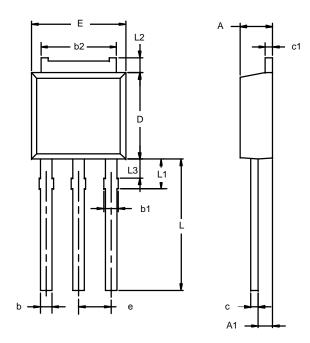
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot



## TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIN	IMETERS INCHE		
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
c1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090 BSC	
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060
ECN: S-0 DWG: 53	3946—Rev. E 346	, 09-Jul-01		



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